



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer, David W	Contact Title	Prod Compliance Engineer for DND		
Company Unique ID	TE Connectivity	Response Date	2017-06-06	Contact Email	dave.benfer@te.com				
Contact Phone Number	717-986-3725								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	2041262-1	Amount	2112.83578	Version	-	Identity			
Manufacturer Item Name	Mini PCI-E 6.8H G/F	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions								
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0616	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	PEGS - Tin Plating				1.0	0.6094	mg	
Substance	2	Tin	Supplier	7440-31-5	100.0	1.0	0.6094	mg	
Material	1	PEGS				1.0	3.88	mg	
Substance	2	Iron	Supplier	7439-89-6	0.07	1.0	0.002716	mg	
Substance	2	Zinc	Supplier	7440-66-6	28.43	1.0	1.10308	mg	
Substance	2	Copper	Supplier	7440-50-8	71.4	1.0	2.77032	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00388	mg	
Material	1	Housing				1.0	1541.4	mg	
Substance	2	Carbon black	Supplier	1333-86-4	1.0	1.0	15.414	mg	
Substance	2	Glass, oxide, chemicals	Supplier	65997-17-3	20.0	1.0	308.28	mg	
Substance	2	1,3-Benzenedicarb oxylic acid, polymer with 1,4-benzenedicarb oxylic acid, [1,1-biphenyl]-4,4-diol and 4-hydroxybenzoic acid	Supplier	60088-52-0	69.0	1.0	1063.566	mg	
Substance	2	Talc (Mg3H2(SiO3)4)	Supplier	14807-96-6	10.0	1.0	154.14	mg	
Material	1	Lower Contact - Nickel Plating				1.0	9.451	mg	
Substance	2	Nickel	Nickel	7440-02-0	100.0	1.0	9.451	mg	
Material	1	Upper Contact - Au Plating				1.0	0.05044	mg	
Substance	2	Carbon	Supplier	7440-44-0	8.3	1.0	0.00418652	mg	
Substance	2	Potassium	Supplier	7440-09-7	13.7	1.0	0.00691028	mg	
Substance	2	Gold	Supplier	7440-57-5	68.3	1.0	0.03445052	mg	
Substance	2	Nitrogen	Supplier	7727-37-9	9.7	1.0	0.00489268	mg	
Material	1	Lower Contact - Au Plating				1.0	0.03874	mg	
Substance	2	Carbon	Supplier	7440-44-0	8.3	1.0	0.00321542	mg	
Substance	2	Potassium	Supplier	7440-09-7	13.7	1.0	0.00530738	mg	
Substance	2	Nitrogen	Supplier	7727-37-9	9.7	1.0	0.00375778	mg	

Substance	2	Gold	Supplier	7440-57-5	68.3	1.0	0.02645942	mg	
Material	1	Upper Contact				1.0	312.0	mg	
Substance	2	Tin	Supplier	7440-31-5	8.0	1.0	24.96	mg	
Substance	2	Copper	Supplier	7440-50-8	91.25	1.0	284.7	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.3	1.0	0.936	mg	
Substance	2	Iron	Supplier	7439-89-6	0.1	1.0	0.312	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.3	1.0	0.936	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.156	mg	
Material	1	Lower Contact				1.0	234.0	mg	
Substance	2	Copper	Supplier	7440-50-8	91.25	1.0	213.525	mg	
Substance	2	Phosphorus	Supplier	7723-14-0	0.3	1.0	0.702	mg	
Substance	2	Zinc	Supplier	7440-66-6	0.3	1.0	0.702	mg	
Substance	2	Iron	Supplier	7439-89-6	0.1	1.0	0.234	mg	
Substance	2	Tin	Supplier	7440-31-5	8.0	1.0	18.72	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.117	mg	
Material	1	PEGS - Nickel Plating				1.0	0.3094	mg	
Substance	2	Nickel	Nickel	7440-02-0	100.0	1.0	0.3094	mg	
Material	1	Upper Contact - Nickel Plating				1.0	11.0968	mg	
Substance	2	Nickel	Nickel	7440-02-0	100.0	1.0	11.0968	mg	